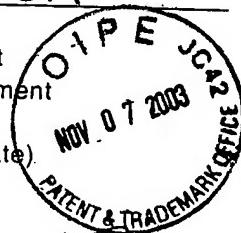


COOK, ALEX, MCFARROW,  
CUMMINGS & MEALER

THE U.S. PATENT & TRADEMARK OFFICE  
OFFICIAL MAILROOM STAMP AFFIXED  
HERETO, ACKNOWLEDGES RECEIPT OF:

ENCLOSURES:

- ( ) Application \_\_\_\_\_  
( ) Specification \_\_\_\_\_ pages  
( ) Claims \_\_\_\_\_ pages  
( ) Abstract \_\_\_\_\_ page(s)  
( ) Drawing Sheets no. \_\_\_\_ (F) \_\_\_\_ (INF) \_\_\_\_  
( ) Transmittal Letter  
( Check \$ 86.00 No: 15019  
( ) Declaration/Oath  
( ) Assignment and Cover Sheet  
( ) Information Disclosure Statement  
( ) Response/Amendment  
( ) Extension of Time (In Duplicate)  
( ) Small Entity Status  
( ) Copy of Priority Document  
( Preliminary Amendment  
( ) \_\_\_\_\_



RE: APPLICATION ATTY/SEC: MJM|SMW

File no: 0553-0166.01

Applicant: Yamazaki et al

S.N.: 10/639069 Filing Date: July 29, 2003  
Wiring material AND A Semiconductor Device  
Title: HAVING A WIRING USING THE MATERIAL AND  
The Manufacturing Method Thereof

Due date: \_\_\_\_\_ Date Sent: 11/4/03

SEL  
0553-0166.01  
EDM/MJM

THE U.S. PATENT & TRADEMARK OFFICE  
OFFICIAL AIRROOM STAMP AFFIXED  
HERETO, ACKNOWLEDGES RECEIPT OF:

ENCLOSURES:

- ( ) Application \_\_\_\_\_  
( ) Specification \_\_\_\_\_ pages  
( ) Claims \_\_\_\_\_ pages  
( ) Abstract \_\_\_\_\_ page(s)  
( ) Drawing Sheets no. \_\_\_\_ (F) \_\_\_\_ (INF) \_\_\_\_  
( ) Transmittal Letter  
(P) Check \$ 86.00 No: 15019  
( ) Declaration/Oath  
( ) Assignment and Cover Sheet  
( ) Information Disclosure Statement  
( ) Response/Amendment  
( ) Extension of Time (In Duplicate)  
( ) Small Entity Status  
( ) Copy of Priority Document  
(X) Preliminary Amendment B

RE: APPLICATION ATTY/SEC: MJM|SMW  
File no: 0553-0166.01

Applicant: Yamazaki et al

S.N.: 101669069 Filing Date: July 29, 2003  
Title: Wiring material AND A Semiconductor Device  
HAVING A WIRING USING THE MATERIAL AND  
The Manufacturing Method Thereof

Due date: \_\_\_\_\_ Date Sent: 11/4/03

COOK ALEX MCFARRON MANZO  
CUMMINGS & MEHLER, LTD.  
200 W. ADAMS ST. • SUITE 2850  
CHICAGO, ILLINOIS 60606  
(312) 236-8500 • FED. ID NO. 36-4307193

LASALLE BANK N.A.  
CHICAGO, ILLINOIS 60603

15019

2-50/710

11/4/2003

\$ 86.00

DOLLARS

Alexander B. Meller  
Cook A. Meller

PAY TO THE  
ORDER OF Commissioner for Patents

Eighty-Six & No/100 Dollars

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

MEMO

THIS DOCUMENT CONTAINS HEAT SENSITIVE INK. TOUCH OR PRESS HERE RED IMAGE DISAPPEARS WITH HEAT.

15019 071000505 5800296120

COOK ALEX MCFARRON MANZO CUMMINGS & MEHLER, LTD.

Invoice Date	Commissioner for Patents Invoice No.	Description
11/4/2003		MJM-smw filing fee

15019

SMW	Matter ID	Amount
	0553-0166.01	86.00



Attorney Docket 0553-0166.01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of )  
Yamazaki et al. )  
Serial No.: 10/629,069 )  
Filed: July 29, 2003 )  
For: Wiring Material And A )  
Semiconductor Device Having A )  
Wiring Using the Material, And The )  
Manufacturing Method Thereof )  
Art Unit: 2811 )  
Examiner: )

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:  
Commissioner for Patents,  
P.O. Box 1450, Alexandria, VA 22313-1450 on

November 4, 2003

(Date of Deposit)

Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 11/4/03

Signature

Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT B**

Sir:

Prior to examination and calculation of the fees, please amend the above-identified application as follows: